

# Engineering/Process Change Notice

#### ECN/PCN No.: 4134

For Manufacturer								
Product Description: PLASTIC SMD MEMS OSCILLATOR	Abracon Part Numb EMR		□ Documentation only □ ECN ⊠ EOL	⊠ Series □ Part Number				
Affected Revision: C	New Revision: EC	)L	Application:	□ Safety ⊠ Non-Safety				
Prior to Change: Active https://abracon.com/datasheets/Ecliptek/	EMRA15.pdf							
After Change: EOL								
Cause/Reason for Change: Discontinuation of manufacturing capabilit	ÿ.							
	Chan	ge Plan						
Effective Date: 2/7/2022	Additional Remarks: N/A							
Change Declaration: N/A	·							
Issued Date: 2/7/2022	Issued By: Brooke C Product E		Issued Department: Engineering					
Approval: Thomas Culhane Engineering Director	Approval: Reuben Qu Quality [		Approval: Ying Huang Purchasing Director					
	For Abrac	on EOL only						
Last Time Buy (if applicable): 5/7/2022	Alternate Part Number / Part Series: ASVDV (7.0x5.0mm)							
Additional Approval:	Additional Approval:		Additional Approval:					
	Customer Appro	val (If Applicable)						
Qualification Status:								
Customer Part Number:		Customer Project:						
Company Name:	Company Representative:		Representative Signature	:				
Customer Remarks:								

Form #7020 | Rev. G | Effective: 02/22/2021 |

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Ecliptek









# REGULATORY COMPLIANCE

Lead Free	2	EU RoHS	China RoHS	REACH
$\bigotimes$		2011/65 + 2015/863	®	SVHC
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### **ITEM DESCRIPTION**

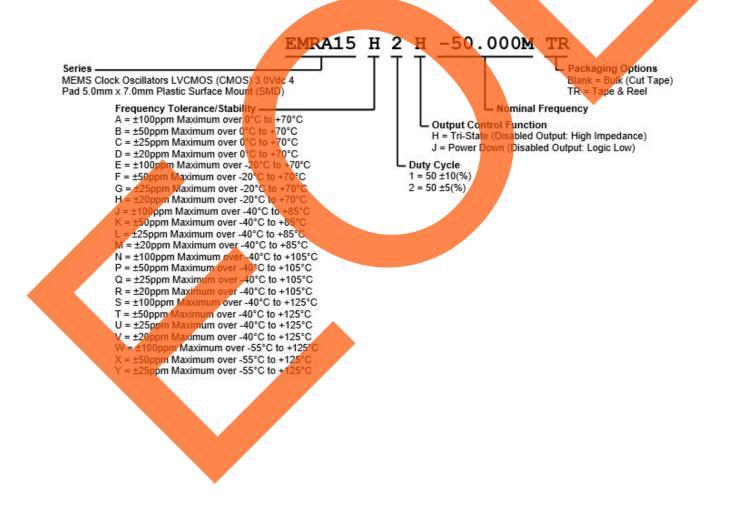
MEMS Clock Oscillators LVCMOS (CMOS) 3.0Vdc 4 Pad 5.0mm x 7.0mm Plastic Surface Mount (SMD)

#### ELECTRICAL SPECIFICATIONS Nominal Frequency 1MHz to 137MHz Inclusive of all conditions: Calibration Tolerance at 25°C, Frequency Stability over the Operating Temperature Range, Frequency Tolerance/Stability Supply Voltage Change, and Output Load Change ±100ppm Maximum over 0°C to +70°C ±50ppm Maximum over 0°C to +70°C ±25ppm Maximum over 0°C to +70°C ±20ppm Maximum over 0°C to +70°C ±100ppm Maximum over -20°C to +70°C ±50ppm Maximum over -20°C to +70°C ±25ppm Maximum over -20°C to +70°C ±20ppm Maximum over -20°C to +70°C ±100ppm Maximum over -40°C to +85°C ±50ppm Maximum over -40°C to +85°C ±25ppm Maximum over -40°C to +85°C ±20ppm Maximum over -40°C to +85°C ±100ppm Maximum over -40°C to +105°C ±50ppm Maxi<mark>mum o</mark>ver -40°C to +105°C ±25ppm Maximum over -40°C to +105°C ±20ppm Maximum over -40°C to +105°C ±100ppm Maximum over -40°C to +125°C ±50ppm Maximum over -40°C to +125°C ±25ppm Maximum over -40°C to +125°C ±20ppm Maximum over -40°C to +125°C ±100ppm Maximum over -55°C to +125°C ±50ppm Maximum over -55°C to +125°C ±25ppm Maximum over -55°C to +125°C Aging at 25°C ±1.5ppm Maximum First Year Supply Voltage 3.0Vdc ±10% Input Current No Load MA Maximum over Nominal Frequency of 1MHz to 20MHz 6mA Maximum over Nominal Frequency of 20.000001MHz to 50MHz MA Maximum over Nominal Frequency of 50.000001MHz to 80MHz 9mA Maximum over Nominal Frequency of 80.000001MHz to 137MHz Output Voltage Logic High (Voh) IOH = -4mA 90% of Vdd Minimum Output Voltage Logic Low (Vol) IOL = +4mA10% of Vdd Maximum **Rise/Fall Time** leasured from 20% to 80% of waveform .2nSec Typical, 3nSec Maximum Measured at 50% of waveform **Duty Cycle** 50 ±10(%) 50 ±5(% Load Drive Capability 15pF Maximum **Output Logic Type** CMOS Tri-State (Disabled Output: High Impedance) **Output Control Function** Power Down (Disabled Output: Logic Low) Output Control Input Voltage Logic 70% of Vdd Minimum or No Connect to Enable Output High (Vih)



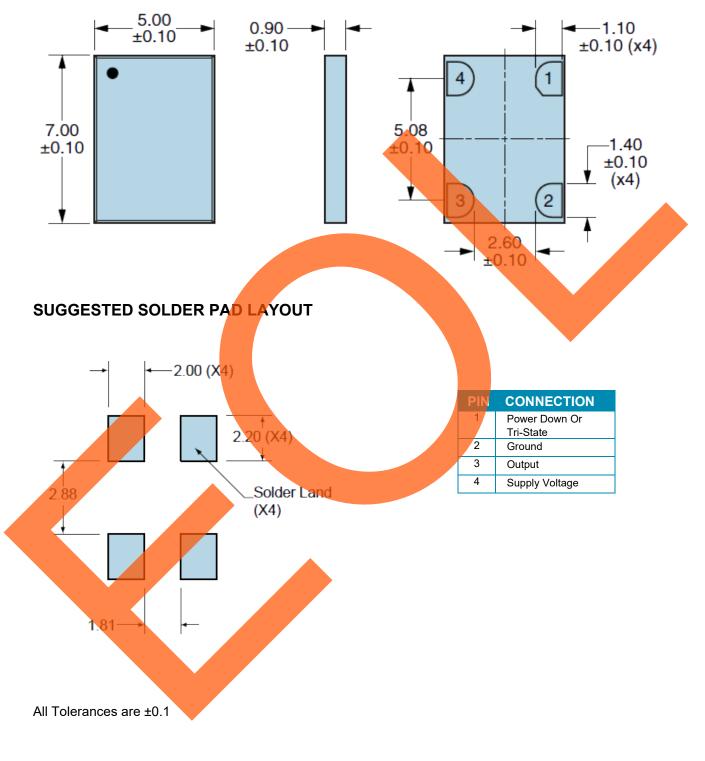
Output Control Input Voltage Logic Low (Vil)	30% of Vdd Maximum to Disable Output	
Power Down Output Enable Time	5mSec Maximum (Disabled Output: Logic Low)	
Tri-State Output Enable Time	150nSec Maximum (Disabled Output: High Impedance)	
Power Down Output Disable Time	150nSec Maximum (Disabled Output: Logic Low)	
Tri-State Output Disable Time	150nSec Maximum (Disabled Output: High Impedance)	
Standby Current	10µA Maximum (Disabled Output: Logic Low)	
Period Jitter (RMS)	2pSec Typical, 4pSec Maximum	
RMS Phase Jitter (Fj = 900kHz to 7.5MHz; Random)	0.5pSec Typical, 1pSec Maximum	
RMS Phase Jitter (Fj = 12kHz to 20MHz; Random)	1.5pSec Typical, 3pSec Maximum	
Start Up Time	5mSec Maximum	
Storage Temperature Range	-65°C to +150°C	

### PART NUMBERING GUIDE





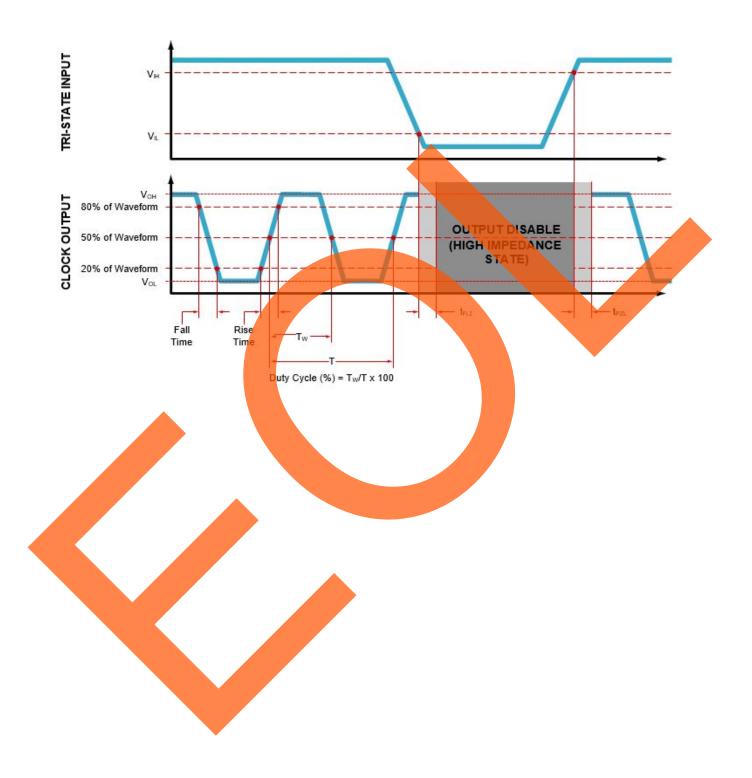
### **MECHANICAL DIMENSIONS**



### **All Dimensions in Millimeters**

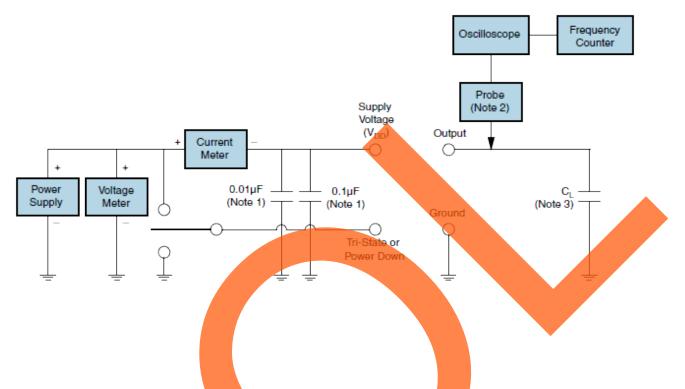


### OUTPUT WAVEFORM & TIMING DIAGRAM





### **TEST CIRCUIT FOR CMOS OUTPUT**



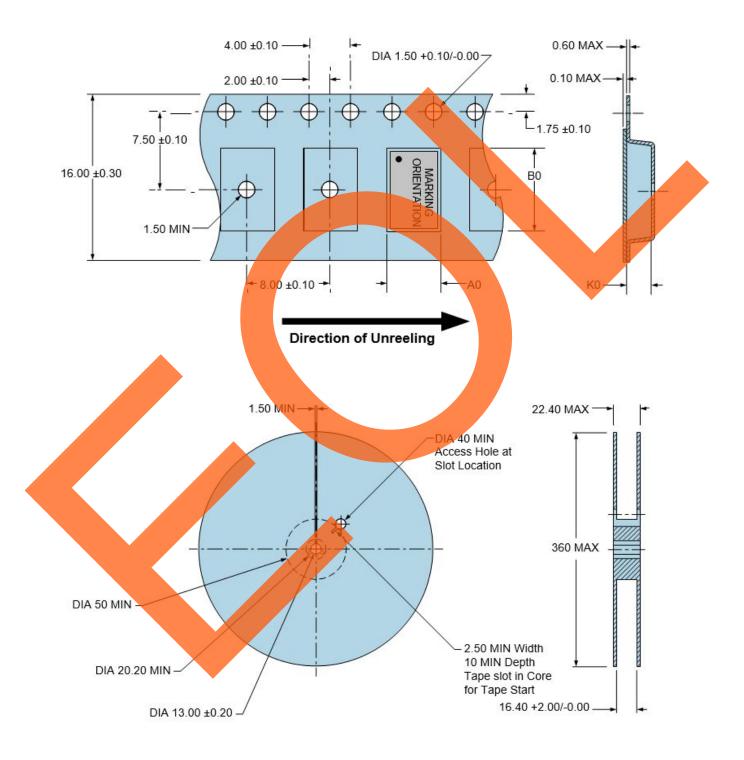
- Note 1: An external 0.01µF ceramic bypass capacitor in parallel with a 0.1µF high frequency ceramic bypass capacitor close (less Than 2mm) to the package ground and supply voltage pin is required.
  Note 2: A low capacitance (<12pF), 10X Attentuation Factor, High Impedance (>10Mohms), and High bandwidth (>300MHz)
- Passive probe is recommended.
- Note 3: Capacitance value CL includes sum of all probe and fixture capacitance. See applicable specification sheet for †Load Drive Capability'.



### **TAPE & REEL DIMENSIONS**

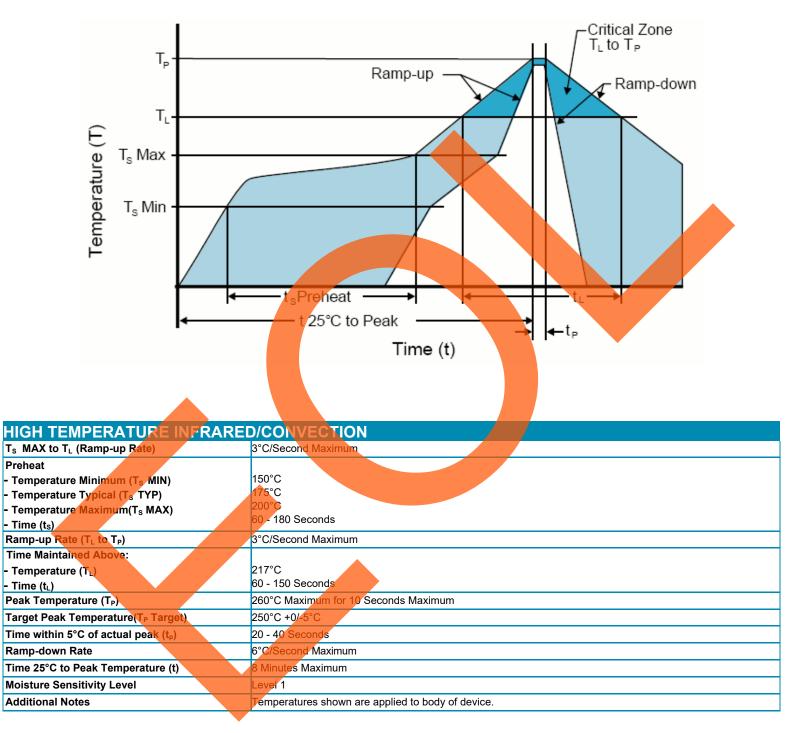
Quantity per Reel: 1000 Units All Dimensions in Millimeters

Compliant to EIA-481





### **RECOMMENDED SOLDER REFLOW METHOD**

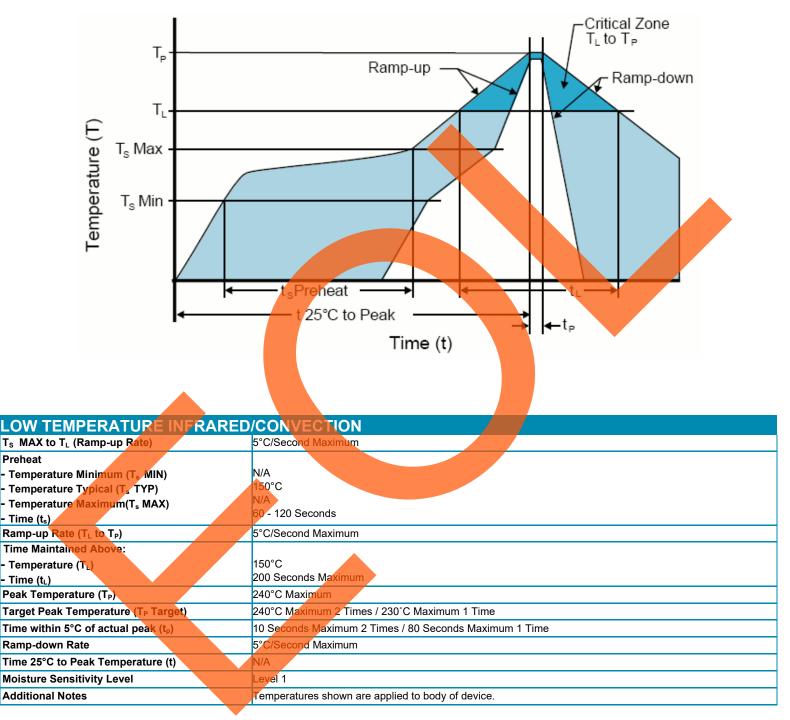


#### High Temperature Manual Soldering

260°C Maximum for 5 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)



### **RECOMMENDED SOLDER REFLOW METHOD**



#### Low Temperature Manual Soldering

185°C Maximum for 10 Seconds Maximum, 2 times Maximum. (Temperatures shown are applied to body of device.)